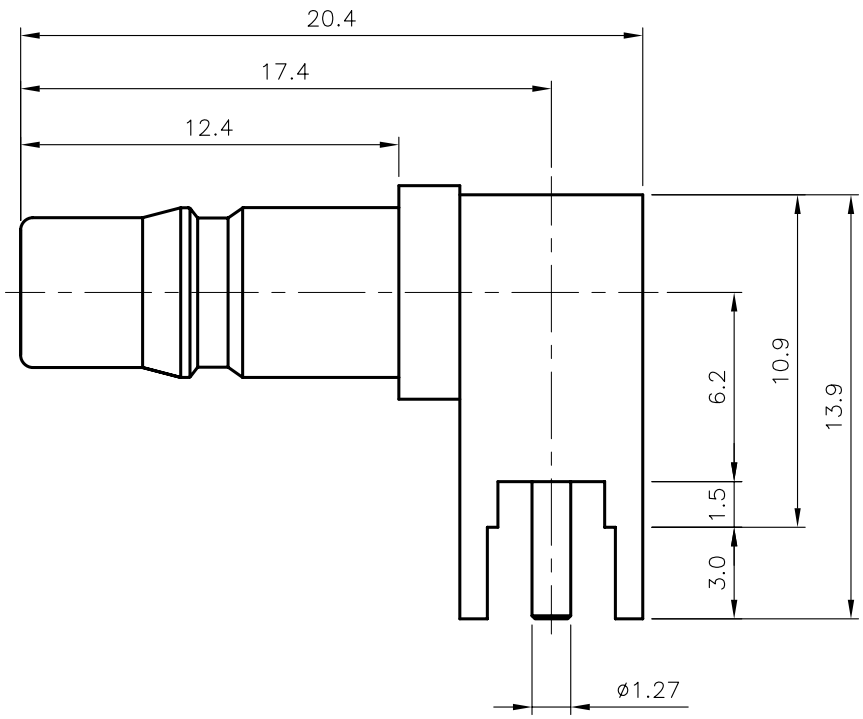
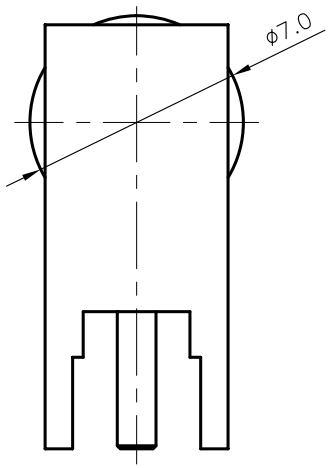
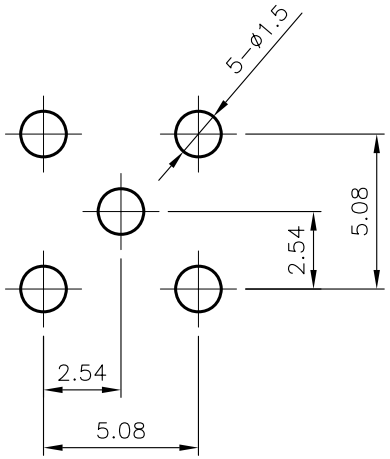
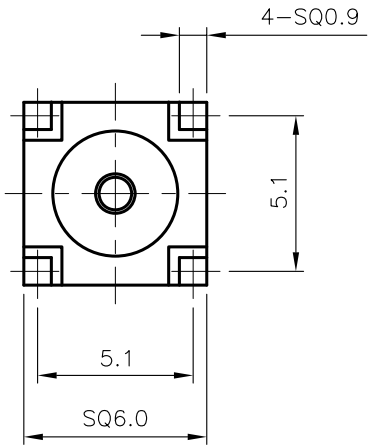
REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.Y.EUN	S.H.KIM	2022.04.07.







RECOMMENDED MOUNTING PCB HOLES



NO.		DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE	
6		COVER	1	MBsBD C3604BD-F	Nickel Plate	DCO00023-5/2	
5		INSULATOR	1	TEFLON		DIN01562-N/1	
4		INSULATOR	1	TEFLON		DIN01895-N/1	
3		CONTACT	1	MBsBD C3604BD-F	Gold Plate	DCT02003-5/1	
2		CONTACT	1	BeCu C17300	Gold Plate	DCT04301-5/1	
1	1-2	BODY	1	MBsBD C3604BD-F	Nickel Plate (납땜성향상)	DBB00520-5/1	DBD04818-1/1
	1-1	BODY	1	MBsBD C3604BD-F			DBD04817-1/1

TOLERANCE	Decimal ±0.2	DATE	2022. 04. 07.
	Angle ±1°	APPROVED BY	S.H.KIM
MATERIAL		CHECKED BY	
		DRAWN BY	S.Y.EUN
FINISH		SCALE 4/1	UNIT mm

KJ COMTECH
KJ COMTECH CO.,LTD.
RF & MICROWAVE TECHNOLOGY
Tel : 82-32-347-8015
Fax : 82-32-347-8017

TITLE
QMA50 PCB JL-4R

A4

DWG NO. CN04049-7/1

REVISION I R

SHEET 1 of 1